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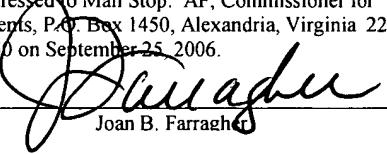
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/085,164 Confirmation No. 8036
Applicants : Kelly et al.
Filed : February 26, 2002
Title: ENCAPSULATED DIE PACKAGE
WITH IMPROVED PARASITIC AND
THERMAL PERFORMANCE
Art Unit : 2814
Examiner : Pham, Hoai V.
Docket No. : A539WTN

MAIL STOP: AF
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**Certificate of Mailing
(37 CFR 1.8(a))**

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Joan B. Farragher

In response to the Final Office Action mailed July 25, 2006 (Paper No. 20060714),
Applicants respectfully submit the following arguments and amendments in the above-referenced
application, and requests entry thereof to place the application in condition for Allowability.

Amendments to the Claims are reflected in the listing of claims that begin on page 2 of
this paper.

Remarks begin on page 11 of this paper.

Conclusion begins on page 15 of this paper.